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### LM95172

# 13-Bit to 16-Bit 200°C Digital Temp Sensor with 3-Wire Interface

### **General Description**

The LM95172EWG is an integrated digital-output temperature sensor with a Serial Peripheral Interface (SPI) and MI-CROWIRE™-compatible interface in a 10-pin Cerpack high temperature ceramic package. It features a very linear Sigma-Delta Analog-to-Digital Converter (ADC), high accuracy, fast conversion rates, and extremely low output noise. With an operating temperature as low as -40°C and optimized accuracy from 120°C to 200°C, it is ideal for high-temperature applications.

The over-temperature alarm output ( $\overline{\text{OVERTEMP}}$ ) asserts when the die temperature exceeds a programmed  $T_{\text{HIGH}}$  limit. The user-programmed  $T_{\text{LOW}}$  limit creates a temperature-stabilizing hysteresis when the ambient temperature is near the trip point.

The LM95172EWG can be programmed to operate from 13 bits (0.0625°C per LSB) to 16 bits (0.0078125°C per LSB) resolution. The LM95172EWG powers up in 35 ms, the fastest conversion time, with temperature output set at 13-bit resolution. The resolution may then be changed to 14-, 15- or 16-bits. When in the 13-, 14- or 15-bit resolution mode, the least significant bit in the 16-bit temperature register toggles after the completion of each conversion. This bit may be monitored to verify that the conversion is complete.

The high noise immunity of the Serial I/O (SI/O) output makes the LM95172EWG ideal for use in challenging electromagnetic environments.

### **Applications**

- Automotive high temperature applications
- Industrial Power Controllers
- Industrial motors, gear boxes
- Geothermal instrumentation
- High Temperature Test Equipment

#### **Features**

- LM95172EWG is AEC-Q100 Grade 0 qualified and is manufactured on an Automotive Grade Flow.
- 13-bit (0.0625°C LSB) to 16-bit (0.0078125°C LSB) temperature resolution
- Wide -40°C to +200°C temperature range
- 35 ms best conversion time tracks fast temp changes
- OVERTEMP digital output switches when T<sub>DIE</sub> > T<sub>HIGH</sub>
- Shutdown mode saves power yet wakes up for one-shot temperature update
- SPI and MICROWIRE Bus interface
- 10-Pin Cerpack high-temperature ceramic package

### **Key Specifications**

■ Analog and Digital Supply	3.0V to 5.5V	
■ Total Supply Current	Operating	400 μA (typ)
Shutdown -40°C t	to +140°C	4 μA (max)
Shutdown -40°C t	to +175°C	12 µA (max)
Shutdown -40°C t	to +200°C	28 µA (max)

■ Temperature Accuracy

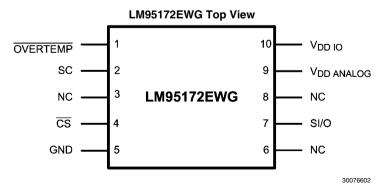
+175°C to +200°C	±3.0°C (max)
+130°C to +160°C	±1.0°C (max)
+120°C to +130°C	±2.0°C (max)
+160°C to +175°C	±2.0°C (max)
-40°C to +120°C	±3.5°C (max)

■ Temperature Resolution

Conversion Time

13-bit mode 43 ms (max) 16-bit mode 350 ms (max)

## **Connection Diagram**

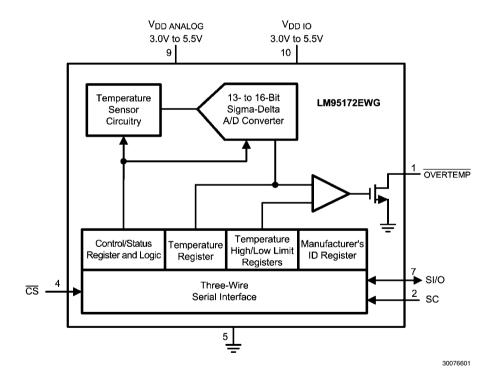


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# **Pin Descriptions**

Pin Number	Name	Туре	Description	Typical Connection	
1	OVERTEMP	Output	OVERTEMP Alarm  Over-temperature Alarm Output, Open-drain.  Low on POR. Requires a pull-up resistor to V		
2	SC	Input	Serial Clock input	Serial clock from the Controller	
3	NC	N/A	No Connect	Do not connect to this pin.	
4	CS	Input	Chip Select input	Chip Select input for the bus. Low pass filtered.	
5	GND	Ground	Power Supply Ground	Ground	
6	NC	N/A	No Connect	Do not connect to this pin.	
7	SI/O	Bidirectio nal	Serial I/O	Serial I/O Data line to or from the Controller	
8	NC	N/A	No Connect	Do not connect to this pin.	
9	V	Power	Analog Power Supply	DC Voltage from 3.0V to 5.5V. Bypass with a 10 nF	
	V <sub>DD ANALOG</sub>	rowei	Voltage	ceramic capacitor near the pad to ground.	
10	$V_{DD\ IO}$	Power	Digital Power Supply Voltage	DC Voltage from 3.0V to 5.5V. Bypass with a 10 nF ceramic capacitor near the pin to ground.	

## **Simplified Block Diagram**



# **Ordering Information**

Order Number	NS Package Number	Transport Media
LM95172EWG	WG10A	54 units in tray

# **Typical Application**

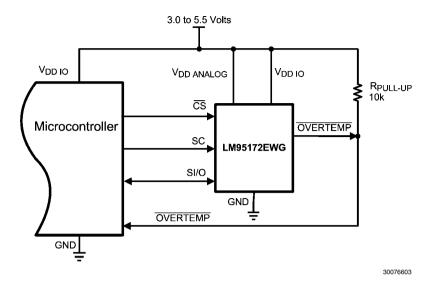


FIGURE 1. Microcontroller Interface - normal connection

### **Absolute Maximum Ratings** (Note 1)

 $\begin{array}{ccc} V_{DD\;ANALOG} \text{ and } V_{DD\;IO} \text{ Supply} \\ \text{Voltages} & -0.2 \text{V to } 6.0 \text{V} \\ \text{Voltage at any Pin} & -0.2 \text{V to } (V_{DD\;IO} + 0.2 \text{V}) \\ \text{Input Current at any Pin} & 5 \text{ mA} \\ \end{array}$ 

Input Current at any Pin 5 mA Storage Temperature -65°C to +175°C

Soldering Information Infrared or Convection

(20 sec.) 235°C

ESD Susceptibility (Note 7)

Human Body Model 2500 V Machine Model 250 V Charged Device Model 1000 V

### **Operating Ratings**

Specified Temperature Range -40°C to +200°C

Analog Supply Voltage Range
VDD ANALOG +3.0V to +5.5V

Digital Supply Voltage Range +3.0V to +5.5V

### **Package Thermal Resistances**

Package	$\theta_{JA}$	
10-Lead CERPACK	175°C/W	

**Temperature-to-Digital Converter Characteristics** Unless otherwise noted, these specifications apply for  $V_{DD\ ANALOG} = V_{DD\ IO} = 3.0V$  to  $3.6V.(Note\ 8)$  **Boldface limits apply for T\_A = -40^{\circ}C to +200^{\circ}C;** all other limits  $T_A = 25^{\circ}C$ , unless otherwise noted.

Parameter	Conditions		Typical (Note 3)	LM95172EWG Limits (Note 2)	Units (Limit)
	$T_A = +175^{\circ}C \text{ to } +200^{\circ}C$			±3.0	
Temperature	$T_A = +130^{\circ}C \text{ to } +160^{\circ}C$			±1.0	
Accuracy	$T_A = +120^{\circ}\text{C to } +130^{\circ}\text{C}$			±2.0	00 ()
(Note 8)	$T_A = +160^{\circ}\text{C to } +175^{\circ}\text{C}$			±2.0	°C (max)
	$T_A = -40^{\circ}\text{C to } +120^{\circ}\text{C}$			±3.5	]
	Res 1 Bit Res 0 Bit 0 0		13 0.0625		Bits °C
Resolution	0 1		14 0.03125		Bits °C
nesolution	1 0		15 0.015625		Bits °C
	1 1		16 0.0078125		Bits °C
	For 13 Bits Resolution			43	
Temperature	For 14 Bits Resolution			87	ms (max)
Conversion Time	For 15 Bits Resolution			175	IIIS (IIIAX)
	For 16 Blts Resolution			350	
		$T_A = -40^{\circ}C$ to 140°C	400	456	
	Bus Inactive Continuous Conversion Mode	$T_A = -40^{\circ}C$ to 175°C		510	
Total Quiescent Current (Note 9)		$T_A = -40$ °C to 200°C	500	650	μA (max)
		$T_A = -40$ °C to 140°C		4	
	Shutdown Mode	$T_A = -40$ °C to 175°C		12	
		$T_A = -40$ °C to 200°C	28	75	

Parameter	Conditions	Typical (Note 3)	LM95172EWG Limits (Note 2)	Units (Limit)
	T _ 40°C to 140°C		0.9	V (min)
	$T_A = -40$ °C to 140°C		2.1	V (max)
Power-On Reset	T-On Reset $T_A = -40^{\circ}\text{C}$ to 175°C		0.8	V (min)
	1 <sub>A</sub> = -40 C to 175 C		2.1	V (max)
	T 40°C to 200°C		0.3	V (min)
	$T_A = -40$ °C to 200°C		2.1	V (max)

# **Logic Electrical Characteristics**

# **Digital DC Characteristics**

Unless otherwise noted, these specifications apply for  $V_{DD\ ANALOG} = V_{DD\ IO} = 3.0V$  to 3.6V. (Note 8). Boldface limits apply for  $T_A = -40^{\circ}C$  to 200°C; all other limits  $T_A = +25^{\circ}C$ , unless otherwise noted.

Symbol	Parameter	Conditions	Typical (Note 3)	Limits (Note 2)	Units (Limit)
V <sub>IH</sub>	Logical "1" Input Voltage			0.75×V <sub>DD IO</sub>	V (min)
V <sub>IL</sub>	Logical "0" Input Voltage			0.25×V <sub>DD IO</sub>	V (max)
·		$V_{DD IO} = 3.0V$	0.63	0.42	V (min)
		$V_{DD IO} = 3.3V$	0.79	0.56	
V Digital In	and thretowns	$V_{DD IO} = 3.6V$	0.97	0.72	
V <sub>HYST</sub> Digital Input Hysteresis		$V_{DD IO} = 4.5V$		0.9	
		$V_{DD IO} = 5.0V$		1.0	
		V <sub>DD IO</sub> = 5.5V		1.1	
I <sub>IH</sub>	Logical "1" Input Leakage Current	$V_{IN} = V_{DD\ IO}$		1	μΑ (max)
I <sub>IL</sub>	Logical "0" Input Current	$V_{IN} = 0V$		-1	μΑ (max)
V	Output High Voltage	I <sub>OH</sub> = 100 μA (Source)		V <sub>DD IO</sub> - 0.2	V (min)
V <sub>OH</sub> Output High Voltage		I <sub>OH</sub> = 2 mA (Source)		V <sub>DD IO</sub> - 0.45	
M	Outrott Law Valtage	I <sub>OL</sub> = 100 μA (Sink)		0.2	V (max)
V <sub>OL</sub> Output Low Voltage		I <sub>OL</sub> = 2 mA (Sink)		0.45	
	OVERTEMP Output Saturation Voltage	I <sub>OL</sub> = 2 mA (Sink)		0.45	V(max)

# **Serial Bus Digital Switching Characteristics**

Unless otherwise noted, these specifications apply for  $V_{DD\,ANALOG} = V_{DD\,IO} = 3.0V$  to 3.6V (Note 8);  $C_L$  (load capacitance) on output lines = 100 pF unless otherwise specified. **Boldface limits apply for T\_A = -40°C to 200°C;** all other limits  $T_A$  = +25°C, unless otherwise noted.

Symbol	Parameter		Limits (Note 2)	Units (Limit)
t <sub>1</sub>	SC (Serial Clock) Period		765	ns (min)
t <sub>2</sub>	CS (Chip Select) Low to SC High Set-Up Time (Note 5)		1.25	μs (min)
t <sub>3</sub>	CS Low to SI/O Output Delay (Note 5)		1	μs (max)
t <sub>4</sub>	SC Low to SI/O Output Delay		120	ns (max)
t <sub>5</sub>	CS High to Data Out (SI/O) TRI-STATE		220	ns (max)
t <sub>6</sub>	SC High to SI/O Input Hold Time		50	ns (min)
t <sub>7</sub>	SI/O Input to SC High Set-Up Time		30	ns (min)
t <sub>8</sub>	SC Low to CS High Hold Time		50	ns (min)
t <sub>TA</sub>	Data Turn-Around Time: SI/O input (write to LM95172EWG) to output (read from LM95172EWG)		130	ns (max)
t <sub>BUF</sub>	Bus free time between communications: $\overline{\text{CS}}$ High to $\overline{\text{CS}}$ Low. (Note 5)		5	μs (min)

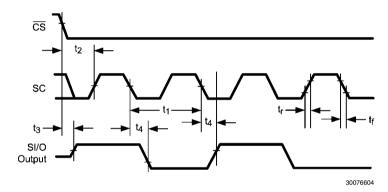


FIGURE 2. Data Output Timing Diagram

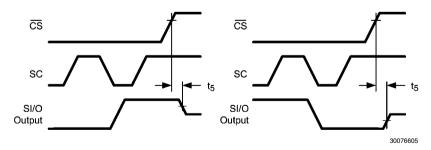


FIGURE 3. TRI-STATE Data Output Timing Diagram

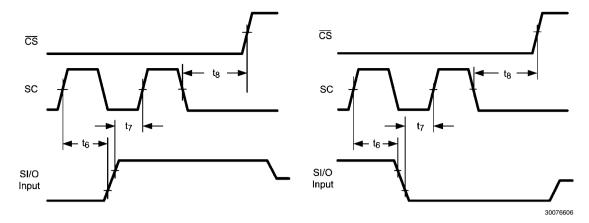


FIGURE 4. Data Input Timing Diagram

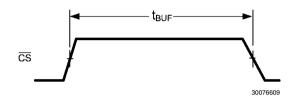


FIGURE 5. t<sub>BUF</sub> Timing Definition Diagram



FIGURE 6. t<sub>TA</sub> Timing Definition Diagram

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Operating Ratings is not implied. The Operating Ratings indicate conditions at which the device is functional and the device should not be operated beyond such conditions.

Note 2: The Electrical characteristics tables list guaranteed specifications under the listed Operating Ratings except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.

**Note 3:** Typical values represent most likely parametric norms at specific conditions (Example Vcc; specific temperature) and at the recommended Operating Conditions at the time of product characterizations and are not guaranteed.

Note 4: Specification is guaranteed by characterization and is not tested in production

Note 5: Specification is guaranteed by design and is not tested in production

Note 6: Invalid. The LM95172EWG will return a "0" if read. If written to, no valid register will be modified.

Note 7: Human body model, 100 pF discharged through a 1.5 k $\Omega$  resistor. Machine model, 200 pF discharged directly into each pin. The Charged Device Model (CDM) is a specified circuit characterizing an ESD event that occurs when a device acquires charge through some triboelectric (frictional) or electrostatic induction processes and then abruptly touches a grounded object or surface.

Note 8: The LM95172EWG will operate properly over the  $V_{DD\ ANALOG} = 3.0V$  to 5.5V and  $V_{DD\ IO} = 3.0V$  to 5.5V supply voltage ranges.

Note 9: Total Quiescent Current includes the sum of the currents into the  $V_{DD\ ANALOG}$  and the  $V_{DD\ IO}$  pins.

Note 10: This specification is provided only to indicate how often temperature data is updated. The LM95172EWG can be read at any time without regard to conversion state (and will yield last conversion result). A conversion in progress will not be interrupted. The output shift register will be updated at the completion of the read and a new conversion restarted.

#### **TRI-STATE Test Circuit**

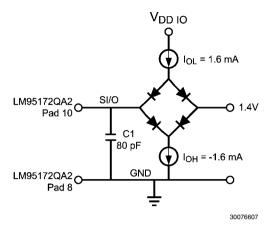


FIGURE 7.

### 1.0 Functional Description

The LM95172EWG temperature sensor incorporates a temperature sensor and a 13-bit to 16-bit  $\Sigma\Delta$  ADC (Sigma-Delta Analog-to-Digital Converter). Compatibility of the LM95172EWG's three wire serial interface with SPI and MI-

CROWIRE allows simple communications with common microcontrollers and processors. Shutdown mode can be used to optimize current drain for different applications. A Manufacturer's/Device ID register identifies the LM95172EWG as National Semiconductor product. See Figure 8 for the Functional Block Diagram.

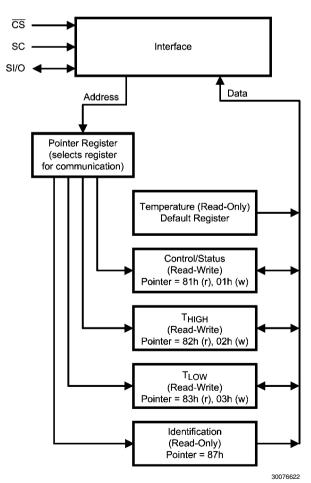


FIGURE 8. LM95172EWG Functional Block Diagram

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# 1.1 INITIAL SOFTWARE RESET AND POWER-UP SEQUENCES AND POWER ON RESET (POR)

#### 1.1.1 Software Reset Sequence

A software reset sequence must be followed, after the initial  $V_{\rm DD\ ANALOG}$  and  $V_{\rm DD\ IO}$  supply voltages reach their specified minimum operating voltages, in order to ensure proper operation of the LM95172EWG.

The software reset sequence is as follows:

- 1. Allow  $V_{DD\;ANALOG}$  and  $V_{DD\;IO}$  to reach their specified minimum operating voltages, as specified in the Operating Ratings section, and in a manner as specified in section 1.1.2 below.
- 2. Write a "1" to the Shutdown bit, Bit 15 of the Control/Status Register, and hold it high for at least the specified maximum conversion time for the initial default of 13-bits resolution, in order to ensure that a complete reset operation has occurred. (See the Temperature Conversion Time specifications within the Temperature-to-Digital Characteristics section.)
- 3. Write a "0" to the Shutdown bit to restore the LM95172EWG to normal mode.
- 4. Wait for at least the specified maximum conversion time for the initial default of 13-bits resolution in order to ensure that accurate data appears in the Temperature Register.

#### 1.1.2 Power-Up Sequence

Warning: In all cases listed below the  $\rm V_{DD\,ANALOG}$  waveform must not lag the  $\rm V_{DD\,IO}$  waveform

A. Linear Power-up

In the case where the  $V_{DD\;ANALOG}$  and  $V_{DD\;IO}$  voltage-vs.-time function is linear, the specified minimum operating voltage must be reached in 5 ms or less.

- B. Resistor-Capacitor (R-C) Charging Exponential Power-up In the case where the  $V_{DD\,ANALOG}$  and  $V_{DD\,IO}$  voltage-vs.-time function is as a typical R-C Charging exponential function the time constant must be less than or equal to 1.25 ms.
- C. Other Power-up Functions

In the case where the  $V_{DD\,ANALOG}$  and  $V_{DD\,IO}$  voltage-vs.-time characteristic follows another function the following requirements must be met:

- (1) The specified minimum operating voltage values for  $V_{\rm DD\ ANALOG}$  and  $V_{\rm DD\ IO}$  must be reached in 5 ms or less.
- (2) The slope of the  $V_{DD\ ANALOG}$  and  $V_{DD\ IO}$  power-up curves must be greater than or equal to 0.7 V/ms at any time before the specified minimum operating voltage is reached.
- (3) The slope of the  $V_{\rm DD\;ANALOG}$  and  $V_{\rm DD\;IO}$  power-up curves must not allow ringing such that the voltage is allowed to drop below the specified minimum operating voltage at any time after the specified minimum operating voltage is reached.

#### 1.1.3 Power On Reset (POR)

After the requirements of section 1.1.1 and 1.1.2 above are met each register will then contain its defined POR default value. Any of the following actions may cause register values to change from their POR value:

- 1. The master writes different data to any Read/Write (R/W) bits or
- 2. The LM95172EWG is powered down.

The specific POR Value of each register is listed in Section 1.7 under Internal Register Structure.

#### 1.2 ONE SHOT CONVERSION

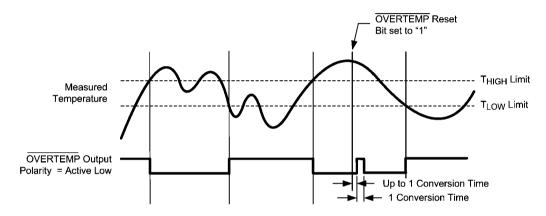
The LM95172EWG features a one-shot conversion bit, which is used to initiate a singe conversion and comparison cycle when the LM95172EWG is in shutdown mode. While the LM95172EWG is in shutdown mode, writing a "1" to the One-Shot bit in the Control/Status Register will cause the LM95172EWG to perform a single temperature conversion and update the Temperature Register and the affected status bits. Operating the LM95172EWG in this one-shot mode allows for extremely low average-power comsumption, making it ideal for low-power applications.

When the One-shot bit is set, the LM95172EWG initiates a temperature conversion. After this initiation, but before the completion of the conversion, and resultant register updates, the LM95172EWG is in a "one-shot" state. During this state, the Data Available (DAV) flag in the Control/Status Register is "0" and the Temperature Register contains the value 8000h

(-256°C). All other registers contain the data that was present before initiating the one-shot conversion. After the temperature measurement is complete, the DAV flag will be set to "1" and the temperature register will contain the resultant measured temperature.

#### **1.3 OVERTEMP OUTPUT**

The Over-temperature (OVERTEMP) output is a temperature switch signal that indicates when the measured temperature exceeds the  $T_{HIGH}$  programmed limit. The programmable  $T_{HIGH}$  register sets the high temperature limit and the  $T_{LOW}$  register is used to set the hysteresis. The  $T_{LOW}$  register also sets the temperature below which the  $\overline{OVERTEMP}$  output resets. The  $\overline{OVERTEMP}$  output of the LM95172EWG behaves as a temperature comparator. The following explains the operation of  $\overline{OVERTEMP}$ . Figure 9 illustrates the  $\overline{OVERTEMP}$  output behavior.



NOTE: The OVERTEMP output asserts when the measured temperature is greater than the T<sub>HIGH</sub> value.

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FIGURE 9. LM95172EWG OVERTEMP vs. Temperature Response Diagram

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The  $\overline{\text{OVERTEMP}}$  Output will assert when the measured temperature is greater than the T<sub>HIGH</sub> value.  $\overline{\text{OVERTEMP}}$  will reset if any of the following events happen:

- 1. The temperature falls below the value stored in the  $\rm T_{LOW}$  register, or
- 2. A "1" is written to the OVERTEMP Reset bit in the Control/ Status Register.

If OVERTEMP is cleared by the master writing a "1" to the OVERTEMP Reset bit while the measured temperature still exceeds the T<sub>HIGH</sub> value, OVERTEMP will assert again after the completion of the next temperature conversion. Placing the LM95172EWG in shutdown mode or triggering a one-shot conversion does not cause OVERTEMP to reset.

#### 1.4 COMMUNICATING WITH THE LM95172EWG

The serial interface consists of three lines:  $\overline{CS}$  (Chip Select), SC (Serial Clock), and the bi-directional SI/O (Serial I/O) data line. A high-to-low transition of the  $\overline{CS}$  line initiates the communication. The master (processor) always drives the chip select and the clock. The first 16 clocks shift the temperature data out of the LM95172EWG on the SI/O line (a temperature read). Raising the  $\overline{CS}$  at anytime during the communication will terminate this read operation. Following this temperature read, the SI/O line becomes an input and a command byte can be written to the LM95172EWG. This command byte

contains a R/ $\overline{W}$  bit and the address of the register to be communicated with next (see Section 1.7 Internal Register Structure). When writing, the data is latched in after every 8 bits. The processor must write at least 8 bits in order to latch the data. If  $\overline{CS}$  is raised before the falling edge of the 8th command bit, no data will be latched into the command byte. If  $\overline{CS}$  is raised after the 8th bit, but before the 16th bit, of a write to a 16-bit data register, only the most significant byte of the data will be latched. This command-data-command-data sequence may be performed as many times as desired.

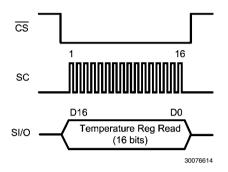


FIGURE 10. Reading the Temperature Register

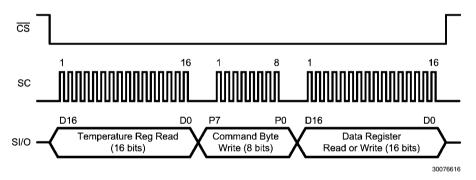


FIGURE 11. Reading the Temperature Register followed by a read or write from another register (Control/Status, T<sub>HIGH</sub>, T<sub>LOW</sub>, or Identification register)

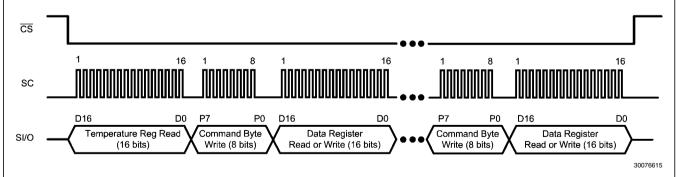


FIGURE 12. Reading the Temperature Register followed by repeated commands and Data Register accesses (Control/Status, T<sub>HIGH</sub>, T<sub>LOW</sub>, or Identification register)

#### 1.5 TEMPERATURE DATA FORMAT

Temperature data is represented by a 13- to 16-bit, two's complement word with a Least Significant Bit (LSB) equal to

0.0625 °C (13-bits), 0.03125 °C (14-bits), 0.015625 °C (15-bits) or 0.0078125 °C (16-bits). See Section 1.7.2 for definition of the bits in the Temperature Register.

13-Bit Resolution. First Bit (D15) is Sign, the last bit (D0) is Toggle and bits D1 and D2 are always 0.

	13-bit Resolu	ition Digital Ou	tput	
Temperature	16-bit Binary	All 16 Bits	Bits D15 - D3	
	10-bit billary	Hex	Hex	
+175°C	0101011110000 000	5780	0AF0	
+1/5 C	0101011110000 001	5781	UAFU	
+150°C	0100101100000 000	4B00	0960	
+150 C	0100101100000 001	4B01	0960	
+80°C	0010100000000 000	2800	0500	
+60 C	0010100000000 001	2801	0300	
+25°C	0000110010000 000	0C80	0190	
+25 C	0000110010000 001	0C81	0190	
+0.0625°C	000000000001 000	8000	0001	
+0.0625 C	000000000001 001	0009	0001	
0°C	00000000000000000	0000	0000	
0.0	0000000000000 001	0001	0000	
0.0605°C	1111111111111 000	FFF8	1FFF	
−0.0625°C	1111111111111 001	FFF9	IFFF	
-40°C	1110110000000 000	EC00	1D80	
_40 C	1110110000000 001	EC01	1000	

#### 14-Bit Resolution. First bit (D15) is Sign, the last bit (D0) is Toggle and bit D1 is always 0.

	14-bit Resolution Digital Output			
Temperature	16-bit Binary	All 16 Bits	Bits D15 - D2	
	10-bit binary	Hex	Hex	
+175°C	01010111100000 00	5780	15E0	
+1/5 C	01010111100000 01	5781	1520	
+150°C	01001011000000 00	4B00	12C0	
+150 C	01001011000000 01	4B01	1200	
. 90°C	00101000000000 00	2800	0A00	
+80°C	00101000000000 01	2801	UAUU	
+25°C	00001100100000 00	0C80	0320	
+25 C	00001100100000 01	0C81	0320	
+0.03125°C	0000000000001 00	0004	0001	
+0.03125 C	0000000000001 01	0005	0001	
0°C	0000000000000000000	0000	0000	
0.0	000000000000000000001	0001	0000	
-0.03125°C	1111111111111 00	FFFC	3FFF	
-0.03125 C	11111111111111 01	FFFD	SFFF	
40°C	11101100000000 00	EC00	3B00	
−40°C	11101100000000 01	EC01	3600	

15-Bit Resolution. First bit (D15) is Sign and the last bit (D0) is Toggle.

	15-bit Resolution Digital Output			
Temperature	16-bit Binary	All 16 Bits	Bits D15 - D1	
	10-bit billary	Hex	Hex	
+175°C	010101111000000 0	5780	2BC0	
+175 C	010101111000000 1	5781	2600	
+150°C	010010110000000 0	4B00	2580	
+150 C	010010110000000 1	4B01	2560	
+80°C	001010000000000 0	2800	1400	
+60 C	001010000000000 1	2801	1400	
+25°C	000011001000000 0	0C80	0640	
+25 C	000011001000000 1	0C81	0040	
+0.015625°C	000000000000001 0	0002	0001	
+0.015025 C	00000000000001 1	0003	0001	
0°C	000000000000000000000000000000000000000	0000	0000	
0.0	00000000000000000001	0001	0000	
-0.015625°C	111111111111111111111111111111111111111	FFFE	7FFF	
-0.013025 C	111111111111111111111111111111111111111	FFFF	/1 [[	
-40°C	111011000000000 0	EC00	7600	
-40 C	111011000000000 1	EC01	7000	

16-Bit Resolution. First bit (D15) is Sign and the last bit (D0) is the LSB.

	16-bit Resolution	Digital Output
Temperature	16 hit Pinony	All 16 Bits
	16-bit Binary	Hex
+175°C	0101 0111 1000 0000	5780
+150°C	0100 1011 0000 0000	4B00
+80°C	0010 1000 0000 0000	2800
+25°C	0000 1100 1000 0000	0C80
+0.0078125°C	0000 0000 0000 0001	0001
0°C	0000 0000 0000 0000	0000
-0.0078125°C	1111 1111 1111 1111	FFFF
-40°C	1110 1100 0000 0000	EC00

The first data byte is the most significant byte with most significant bit first, permitting only as much data as necessary to be read to determine temperature condition. For instance, if the first four bits of the temperature data indicate an overtemperature condition, the host processor could immediately take action to remedy the excessive temperatures.

#### **1.6 SHUTDOWN MODE**

Shutdown Mode is enabled by writing a "1" to the Shutdown Bit, Bit 15 of the Control/Status Register, and holding it high for at least the specified maximum conversion time at the ex-

isting temperature resolution setting. (see Temperature Conversion Time specifications under the Temperature-to-Digital Characteristics section). For example, if the LM95172EWG is set for 16-bit resolution before shutdown, then Bit 15 of the Control/Status register must go high and stay high for the specified maximum conversion time for 16-bits resolution.

The LM95172EWG will always finish a temperature conversion and update the temperature registers before shutting down.

Writing a "0" to the Shutdown Bit restores the LM95172EWG to normal mode.

#### 1.7 INTERNAL REGISTER STRUCTURE

The LM95172EWG has four registers that are accessible by issuing a command byte (a R/W Bit plus the register address: Control/ Status, T<sub>HIGH</sub>, T<sub>LOW</sub>, and Identification. Which of these registers will be read or written is determined by the Command Byte. See Section 1.4, "Communicating with the LM95172EWG", for a complete description of the serial communication protocol. The following diagram describes the Command Byte and lists the addresses of the various registers. On power-up, the Command Byte will point to the Temperature Register by default. The temperature is read by lowering the  $\overline{\text{CS}}$  line and then reading the 16-Bit temperature register; all other registers are accessed by writing a Command Byte after reading the temperature.

All registers can be communicated with, either in Continuous Conversion mode or in Shutdown mode. When the LM95172EWG has been placed in Shutdown Mode, the Temperature register will contain the temperature data which resulted from the last temperature conversion (whether it was the result of a continuous-conversion reading or a one-shot reading).

#### 1.7.1 Command Byte

P7	P6	P5	P4	P3	P2	P1	P0
R/W	0	0	0	0	Register Select		

Bit <7> Read/Write Bit. Tells the LM95172EWG if the host will be writing to, or reading from, the register to which this byte is pointing.

Bits <6:3> Not Used. These Bits must be zero. If an illegal address is written, the LM95172EWG will return 0000h on the subsequent read.

Bits <2:0> Pointer Address Bits. Points to desired register. See table below.

P2	P1	P0	Register
0	0	0	Invalid. (Note 6)
0	0	1	Control/Status
0	1	0	T <sub>HIGH</sub>
0	1	1	T <sub>LOW</sub>
1	0	0	
1	0	1	Invalid. (Note 6)
1	1	0	
1	1	1	Identification

Power-On Reset state: 00h

Reset Conditions: Upon Power-on Reset

#### 1.7.2 Temperature Register

(Read Only): Default Register

D15	D14	D13	D12	D11	D10	D9	D8
Sign	128°C	64°C	32°C	16°C	8°C	4°C	2°C

D7	D6	D5	D4	D3	D2	D1	D0
1°C	0.5°C	0.25°C	0.125°C	0.0625°C	0.03125°C	0.015625°C	Conversion - Toggle/ 0.0078125°C

Bit <15:1>: Temperature Data Byte. Reperesents the temperature that was measured by the most recent temperature conversion in two's complement form. On power-up, this data is invalid until the DAV Bit in the Control/Status Register is high (that is, after completion of the first conversion).

The resolution is user-programmable from 13-Bit resolution (0.0625°C) through 16-Bit resolution (0.0078125°C). The desired resolution is programmed through Bits 4 and 5 of the Control/Status Register. See the description of the Control/Status Register for details on resolution selection.

The Bits not used for a selected resolution are always set to "0" and are not to be considered part of a valid temperature reading. For example, for 14-Bit resolution, Bit <1> is not used and, therefore, it is invalid and is always zero.

Bit <0>: Conversion Toggle or, if 16-Bit resolution has been selected, this is the 16-Bit temperature LSB.

When in 13-Bit, 14-Bit, or 15-Bit resolution mode, this Bit toggles each time the Temperature register is read if a conversion has completed since the last read. If conversion has not completed, the value will be the same as the last read.

When in 16-Bit resolution mode, this is the Least Significant Bit of the temperature data.

Reset Conditions: See Sections 1.1.1 through 1.1.3 for reset conditions.

One-Shot State: 8000h (-256°C)

#### 1.7.3 Control/Status Register

(Read/Write) Pointer Address: 81h (Read); 01h (Write)

D15	D14	D13	D12	D11	D10	D9	D8
SD	One-Shot	OVERTEMP	Conversion	OVERTEMP	т	т	DAV
30		Reset	Toggle	Status	HIGH	LOW	

D7	D6	D5	D4	D3	D2	D1	D0
OVERTEMP	OVERTEMP	RES1	RES0	0	reserved	reserved	0
Disable	POL	11201	11200	"	lescived	lescived	~

Bit <15>: Shutdown (SD) Bit. Writing a "1" to this bit and holding it high for at least the specified maximum conversion time, at the existing temperature resolution setting, enables the Shutdown Mode. Writing a "0" to this bit restores the LM95172EWG to normal mode.

Bit <14>: One-Shot Bit. When in shutdown mode (Bit <15> is "1"), initates a single temperature conversion and update of the temperature register with new temperature data. Has no effect when in continuous conversion mode (i.e., when Bit <15> is "0"). Always returns a "0" when read.

Bit <13>: OVERTEMP Reset Bit. Writing a "1" to this Bit resets the OVERTEMP Status bit and, after a possible wait up to one temperature conversion time, the OVERTEMP pin. It will always return a "0" when read.

Bit <12>: Conversion Toggle Bit. Toggles each time the Control/Status register is read **if** a conversion has completed since the last read. If conversion has not been completed, the value will be the same as last read.

Bit <11>:  $\overline{\text{OVERTEMP}}$  Status Bit. This Bit is "0" when  $\overline{\text{OVERTEMP}}$  output is low and "1" when  $\overline{\text{OVERTEMP}}$  output is high. The  $\overline{\text{OVERTEMP}}$  output is reset under the following conditions: (1) Cleared by writing a "1" to the  $\overline{\text{OVERTEMP}}$  Reset Bit (Bit <13>) in this register or (2) Measured temperature falls below the  $T_{\text{LOW}}$  limit. If the temperature is still above  $T_{\text{HIGH}}$ , and  $\overline{\text{OVERTEMP}}$  Reset is set to "1", then the Bit and the pin clear until the next conversion, at which point the Bit and pin would assert again.

Bit <10>: Temperature High ( $T_{HIGH}$ ) Flag Bit. This Bit is set to "1" when the measured temperature exceeds the  $T_{HIGH}$  limit stored in the programmable  $T_{HIGH}$  register. The flag is reset to "0" when both of two conditions are met: (1) temperature no longer exceeds the programmed  $T_{HIGH}$  limit **and** (2) upon reading the Control/Status Register. If the temperature no longer exceeds the  $T_{HIGH}$  limit, the status Bit remains set until it is read by the master so that the system can check the history of what caused the  $T_{HIGH}$  to assert.

Bit <9>: Temperature Low ( $T_{LOW}$ ) Flag Bit. This Bit is set to "1" when the measured temperature falls below the  $T_{LOW}$  limit stored in the programmable  $T_{LOW}$  register. The flag is reset to "0" when both of two conditions are met: (1) temperature is no longer below the programmed  $T_{LOW}$  limit **and** (2) upon reading the Control/Status Register. If the temperature is no longer below, or equal to, the  $T_{LOW}$  limit, the status Bit remains set until it is read by the master so that the system can check the history of what caused the  $\overline{OVERTEMP}$  to assert.

Bit <8>: Data Available (DAV) Status Bit. This Bit is "0" when the temperature sensor is in the process of converting a new temperature. It is "1" when the conversion is done. It is reset after each read and goes high again after one temperature conversion is done. In one-shot mode: after initiating a temperature conversion while operating, this status Bit can be monitored to indicate when the conversion is done. After triggering the one-shot conversion, the data in the temperature register is invalid until this Bit is high (i.e., after completion of the first conversion).

Bit <7>: OVERTEMP Disable Bit. When set to "0" the OVERTEMP output is enabled. When set to "1" the OVERTEMP output is disabled. This Bit also controls the OVERTEMP Status Bit (this register, Bit <11>) since that Bit reflects the state of the OVERTEMP pin.

Bit <6>: OVERTEMP Polarity Bit. When set to "1", OVERTEMP is active-high. When "0" it is active-low.

#### **Control/Status Register (Continued)**

Bit <5:4>: Temperature Resolution Bits. Selects one of four user-programmable temperature data resolutions as indicated in the following table.

	l/Status ister	Re	esolution
Bit 5	Bit 4	Bits	°C
0	0	13	0.0625
0	1	14	0.03125
1	0	15	0.015625
1	1	16	0.0078125

Bit <3>: Always write a zero to this Bit.

Bit <2:1>: Reserved Bits. Will return whatever was last written to them. Value is zero on power-up.

Bit <0>: Always write a zero to this Bit.

Reset State: 0000h

Reset Conditions: Upon Power-on Reset.

#### 1.7.4 T<sub>HIGH</sub>: Upper Limit Register

(Read/Write) Pointer Address: 82h (Read); 02h (Write)

D15	D14	D13	D12	D11	D10	D9	D8
Sign	128°C	64°C	32°C	16°C	8°C	4°C	2°C

	D7	D6	D5	D4	D3	D2	D1	D0
ſ	1°C	0.5°C	0.25°C	Reserved				

Bit <15:5>: Upper-Limit Temperature byte. If the measured temperature, stored in the temperature register, exceeds this user-programmable temperature limit, the  $\overline{\text{OVERTEMP}}$  pin will assert and the T<sub>HIGH</sub> flag in the Control/Status register will be set to "1".

Bit <4:0>: Reserved. Returns all zeroes when read.

Reset State: 4880h (+145°C)

Reset Conditions: Upon Power-on Reset.

#### 1.7.5 T<sub>LOW</sub>: Lower Limit Register

(Read/Write) Pointer Address: 83h (Read); 03h (Write)

D15	D14	D13	D12	D11	D10	D9	D8
Sign	128°C	64°C	32°C	16°C	8°C	4°C	2°C

D7	D6	D5	D4	D3	D2	D1	D0	
1°C	0.5°C	0.25°C		Reserved				

Bit <15:5>: Lower-Limit Temperature byte. If the measured temperature that is stored in the temperature register falls below this user-programmable temperature limit, the OVERTEMP pin will not assert and the T<sub>LOW</sub> flag in the Control/Status register will be set to "1".

Bit <4:0>: Reserved. Returns all zeroes when read.

Reset State: 4600h (+140°C)

Reset Conditions: Upon Power-on Reset.

#### 1.7.6 MFGID: Manufacturer, Product, and Step ID Register

(Read Only) Pointer Address: 87h

D15	D14	D13	D12	D11	D10	D9	D8
1	0	0	0	0	0	0	0

D7	D6	D5	D4	D3	D2	D1	D0
0	0	1	1	0	0	0	0

Bit <15:8>: Manufacturer Identification Byte. Always returns 80h to uniquely identify the manufacturer as National Semiconductor Corporation.

Bit <7:4>: Product Identification Nibble. Always returns 30h to uniquely identify this part as the LM95172EWG.

Bit <3:0>: Die Revision Nibble. Returns 0h to uniquely identify the revision level as zero.

Reset State: 8030h

Reset Conditions: Upon Power-on Reset.

# 2.0 Typical Applications

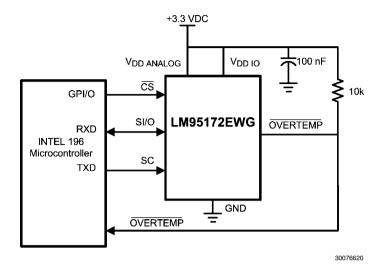


FIGURE 13. Temperature monitor using Intel 196 processor

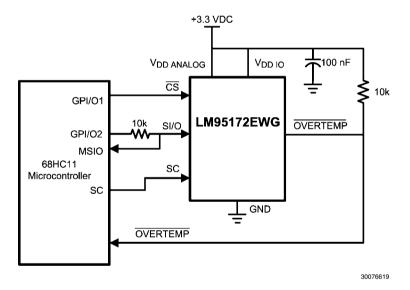
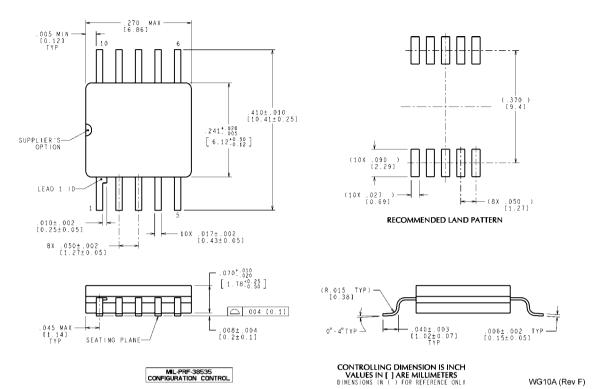


FIGURE 14. LM95172EWG digital input control using microcontroller's general purpose I/O.

# Physical Dimensions inches (millimeters) unless otherwise noted



10-pin Cerpack Package LM95172EWG

### **Notes**

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Interface	www.national.com/interface	Eval Boards	www.national.com/evalboards	
LVDS	www.national.com/lvds	Packaging	www.national.com/packaging	
Power Management	www.national.com/power	Green Compliance	www.national.com/quality/green	
Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts	
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality	
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback	
Voltage References	www.national.com/vref	Design Made Easy	www.national.com/easy	
PowerWise® Solutions	www.national.com/powerwise	Applications & Markets	www.national.com/solutions	
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero	
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